

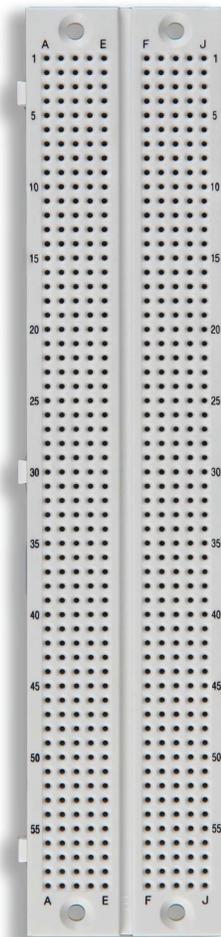
GS-590

590 TIE-POINT, SOLDERLESS BREADBOARD

Applications

The GS-590 is a modular type solderless breadboard that connects with the GS-090 bus strip to make a 770 tie point breadboard (GS-770). Expandable, it is a great way to prototype low frequency or DC powered circuits. It is ideal for:

- Educational labs
- Hobbyists



Features

- 590 Tie-points
- ABS plastic body
- Round hole style
- Interlocking tabs
- Peel and stick adhesive
- Nickel plated phosphor bronze spring clip contacts
- Allowable wire diameter of 0.4-0.7 mm
- Fits 7 total 16-pin ICs
- Measures 6.5 x 1.375 x 0.33 in
- Maximum capacity of 1.5 A at 36 V
- RoHS compliant
- Three-year warranty

GS-590

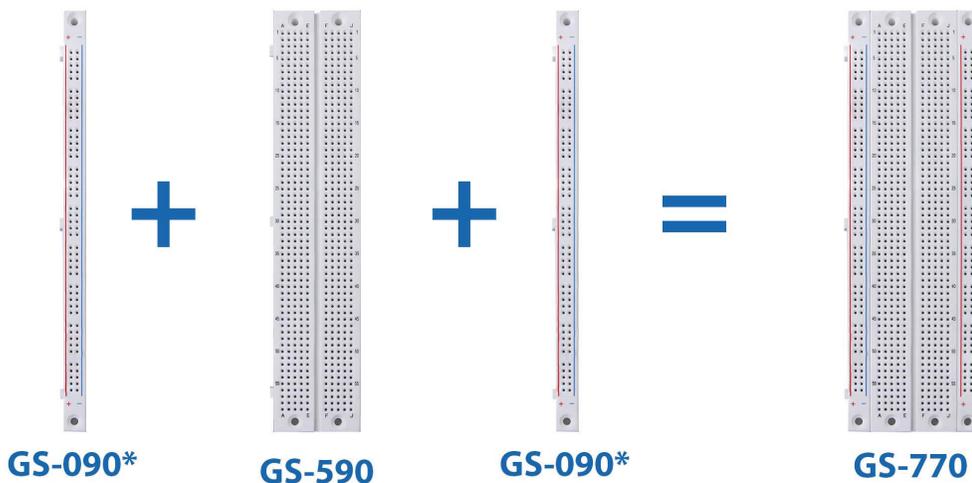
590 TIE-POINT, SOLDERLESS BREADBOARD

Applications

The GS-590 is a modular type solderless breadboard that connects with the GS-090 bus strip to make a 770 tie point breadboard (GS-770). Expandable in two dimensions, it is a great way to prototype low frequency or DC powered circuits. They are ideal for:

- Educational labs
- Hobbyists

GS-770 Components



*The GS-090 is sold as a pack of two